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4.3 Schematic

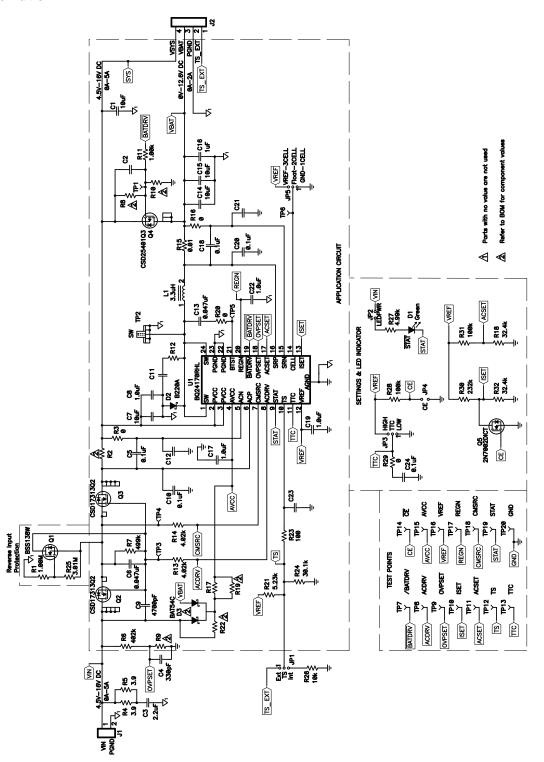


Figure 8. bq24170EVM Schematic

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